

SPECIFICATIONS

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

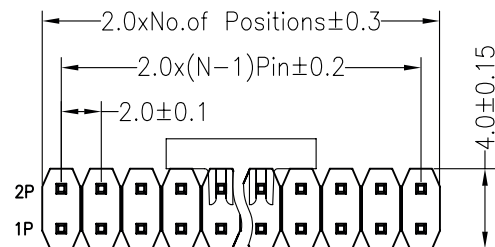
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

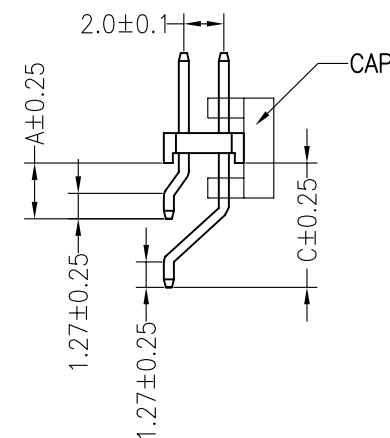
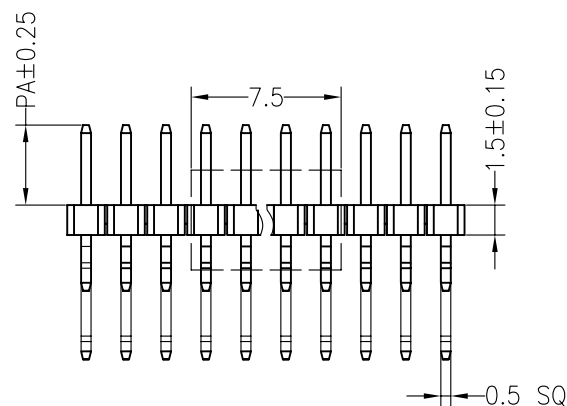
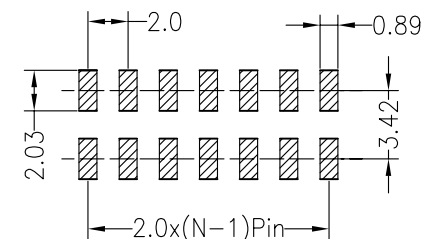
Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



FAMILY	PITCH	N° ROWS	N° PIN P.R.	VERSION	CLIP PLATING	HEIGHT	OPTION	SP_CODE*	PCB LAYOUT	SPECIAL	PACKAGE
PH	200	2	XX	N (SMD_R/A)	F (flash gold)	XXX (length_PA)	F (isol. 2,0)	--	0 (without PEG)	0 (standard)	T (tube)
							C (isol. 1,5)				W (reel+caps)
											V (tray / bag)

Dimension antitheses list			
ITEM	PA	A	C
Standard	4.00	3.40	6.25
Alternate			

*SP_CODE alternate for customer



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FILE N. E356435

UNITS: mm

SHEET SIZE: ISO A4

SCALE:

> 0 ~ 3

> 3 ~ 18

> 18 ~ 50

> 50 ~ 120

± 0.12

± 0.15

± 0.3

± 0.5



First angle projec on

HEADER